			H′
	Application No.	Applicant(s)	
A4 .4	10/803,333	SHIN ET AL.	
Notice of Allowability	Examiner	Art Unit	
	Chuong A. Luu	2818	
The MAILING DATE of this communication apperature All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RI of the Office or upon petition by the applicant. See 37 CFR 1.313	(OR REMAINS) CLOSED in th or other appropriate communic GHTS. This application is subj	is application. If not include cation will be mailed in due	ed course. THIS
1. This communication is responsive to 6/6/2005.			(
2. ☑ The allowed claim(s) is/are <u>36-42</u> .			\ .
3. The drawings filed on 17 March 2004 are accepted by the	Examiner.		
 4. Acknowledgment is made of a claim for foreign priority una) All b) Some* c) None of the: Certified copies of the priority documents have Certified copies of the priority documents have Copies of the certified copies of the priority documents have Copies of the certified copies of the priority documents have International Bureau (PCT Rule 17.2(a)). * Certified copies not received:	been received. been received in Application N	No. <u>09/574,541</u> .	ation from the
Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONM THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.	ENT of this application.		
5. A SUBSTITUTE OATH OR DECLARATION must be submit INFORMAL PATENT APPLICATION (PTO-152) which give	itted. Note the attached EXAMI es reason(s) why the oath or de	NER'S AMENDMENT or Neclaration is deficient.	OTICE OF
6. CORRECTED DRAWINGS (as "replacement sheets") mus	t be submitted.		
(a) \square including changes required by the Notice of Draftspers	on's Patent Drawing Review (PTO-948) attached	
1) ☐ hereto or 2) ☐ to Paper No./Mail Date			
(b) ☐ including changes required by the attached Examiner's Paper No./Mail Date	s Amendment / Comment or in	the Office action of	
Identifying indicia such as the application number (see 37 CFR 1. each sheet. Replacement sheet(s) should be labeled as such in the	84(c)) should be written on the d ne header according to 37 CFR 1	rawings in the front (not the	back) of
7. DEPOSIT OF and/or INFORMATION about the deposit attached Examiner's comment regarding REQUIREMENT I	sit of BIOLOGICAL MATERI FOR THE DEPOSIT OF BIOLO	IAL must be submitted. I OGICAL MATERIAL.	Note the
Attachment(s)		•	•
1. Notice of References Cited (PTO-892)	5. Notice of Inform	mal Patent Application (PT0	O-152)
2. Notice of Draftperson's Patent Drawing Review (PTO-948)	6. Interview Sum		
3. Information Disclosure Statements (PTO-1449 or PTO/SB/0-Paper No./Mail Date 6/6/2005	8), 7. ☐ Examiner's Am	il Date nendment/Comment	
4. Examiner's Comment Regarding Requirement for Deposit	8. 🛛 Examiner's Sta	tement of Reasons for Allo	wance
of Biological Material	9. Other		

DETAILED ACTION

Allowable Subject Matter

Claims 36-42 are allowed.

The following is an examiner's statement of reasons for allowance: The examiner has reviewed the prior art in light of applicant's claimed invention and finds that the combined claims define over the prior art. The cited prior art does not disclose or suggest a stackable semiconductor package device inter alia the limitations "..a semiconductor chip in the through hole, wherein the semiconductor chip has a first surface flush with the first surface of the substrate, and an opposite second surface including a plurality of conductive pads, the pads being oriented in a same direction as the second surface of the substrate, wherein the first surface of the semiconductor chip is exposed; a plurality of conductive connecting means, wherein each of the conductive connecting means is electrically connected between a respective one of the pads of the second surface of the semiconductor chip and a respective one of the bond fingers of the circuit patterns of the second surface of the substrate; a hardened encapsulant within the through hole and covering the semiconductor chip therein, the bond fingers, the pads, and the conductive connecting means, wherein the lands of the circuit patterns of each of the first and second surfaces of the substrate are outward of a perimeter of the encapsulant..."

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably Application/Control Number: 10/803,333 Page 3

Art Unit: 2818

accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chuong A. Luu whose telephone number is (571) 272-1902. The examiner can normally be reached on M-F (6:15-2:45).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David C. Nelms can be reached on (571) 272-1787. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

> Chuong Anh Luu Patent Examiner

August 18, 2005